



# ACGI020022-P43-1

## S-band matched GaAs Device

### Features:

Frequency: 2~2.2GHz

1dB Output Power :  $P_{1dB} \geq 43\text{dBm}$

PowerGain: Gain  $\geq 10.5\text{dB}$

Efficiency:  $\eta = 45\%$  (type)

Port matching:  $Z_{in}/Z_{out} = 50\Omega$

### Description:

ACGI020022-P43-1 is an internal matching GaAs device, which adopts advanced co-planar internal matching MCM and thin film circuit technology. The typical working frequency range is 2~2.2GHz. This device can be used in different RF/Microwave system and subsystem. The high output power level, high efficiency and wide operating temperature range can make application very flexible.

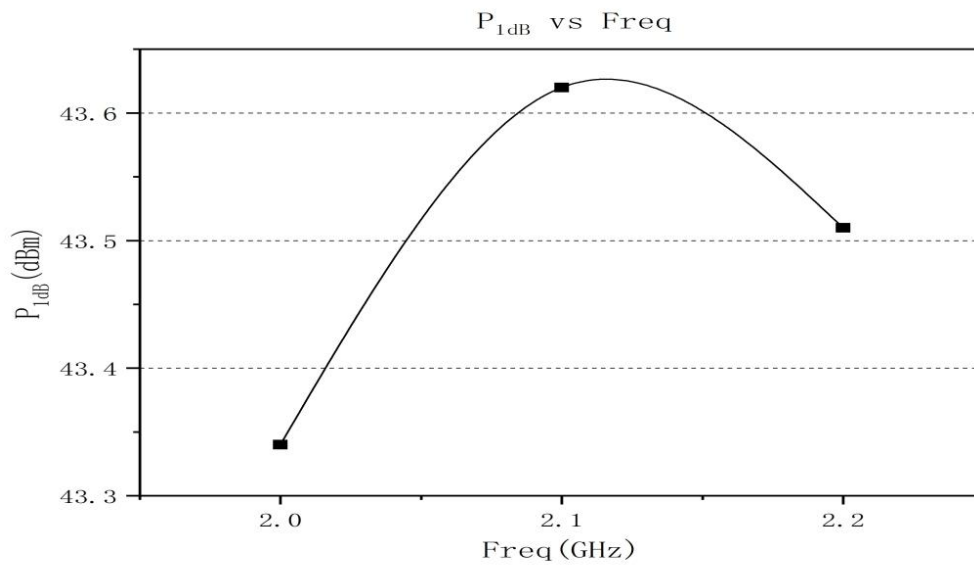
Maximun Ratings (TC=25°C, Not recommended working under this condition):

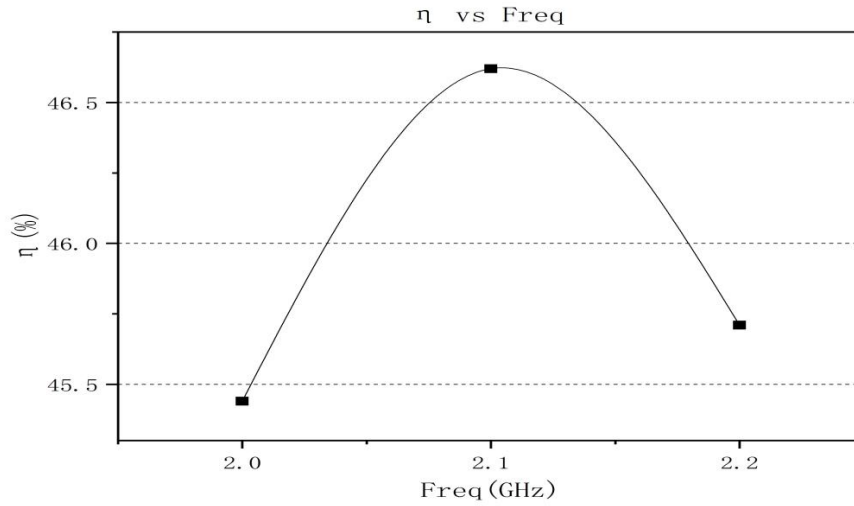
	Symbol	Value	Unit
Voltage between source and drain	$V_{ds}$	11	V
Voltage between gate and source	$V_{gs}$	-3	V
Storage Temperature Range	$T_{stg}$	-65 to +150	°C
Drain and Source Channel Temperature	$T_{ch}$	150	°C

## Electrical Characteristics:

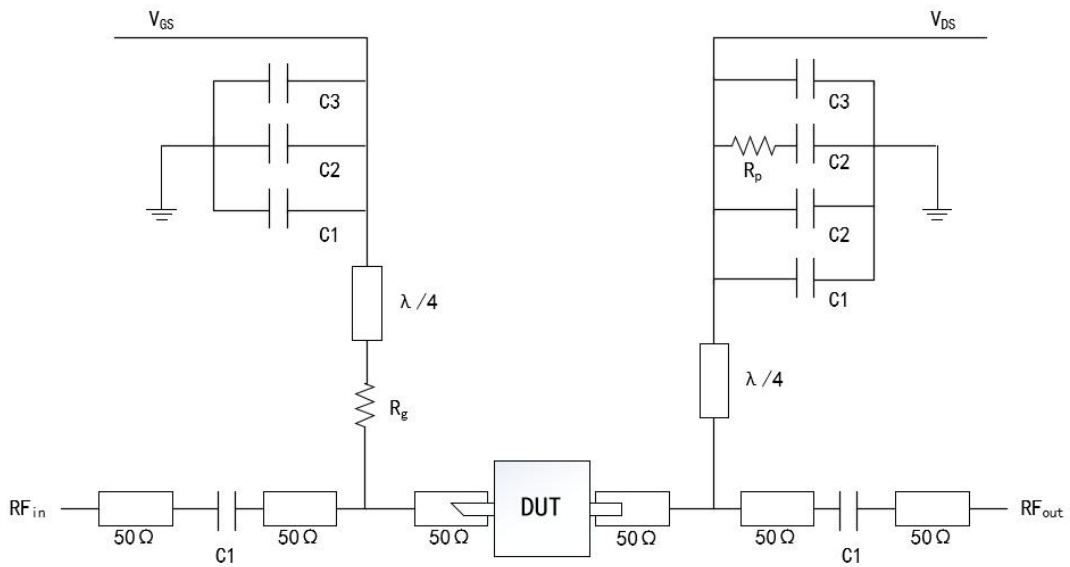
	Symbol	Test condition	Value			Unit
			Min	Typ	Max	
Drain Current	$I_{dsr}$	Vds= 10V CW. Pin: 32.5dBm Freq: 2~2.2GHz	-	4.4	-	A
1dB output power	$P_{1dB}$		43	-	-	dBm
Gain	$G_p$		10.5	-	-	dB
Efficiency	$\eta$		-	45	-	%
Gain Flatness	$\Delta G$		-0.8	-	+0.8	dB

## Typical Curve:





## Application Circuit:



### DUT: Device to be tested

C1:8pF

$R_p$ :51Ω

C2:1000pF

$R_g$ :15Ω

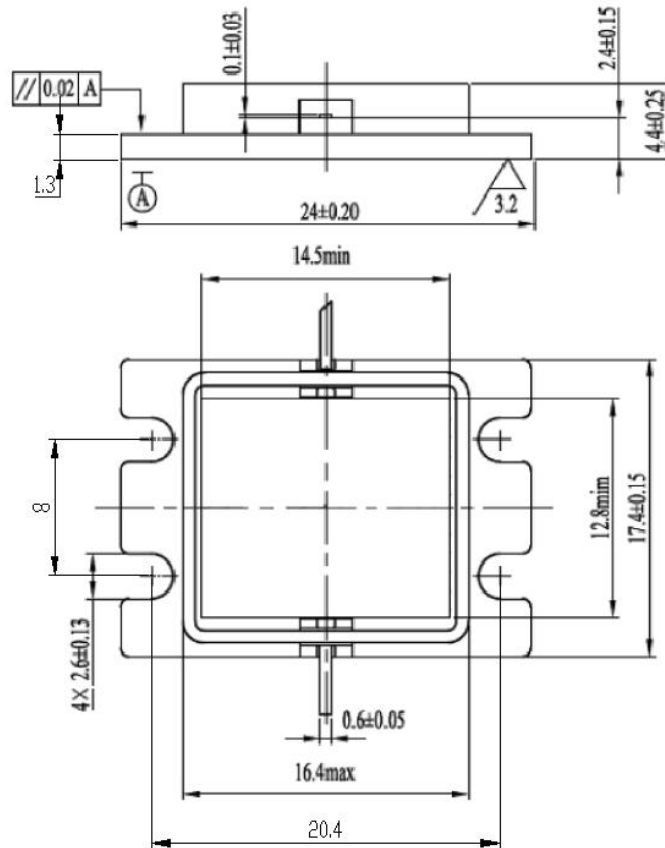
C3:100uF

If you need more detailed product information, please contact our marketing personnel or designers.  
 Contact: Peter.Zhang Email: peter.zhang@anserrf.com

## ESD Level:

ESD	Class III	2000V
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## Outline:



## Precautions for use:

- Pay attention to drying transportation and storage.
- Pay attention to anti-static during chip use and assembly, and wear grounding anti-static bracelet.
- When powering up, first apply grid power then add leakage.